

General Description

The MAX1922 current-limited $70m\Omega$ switch with built-in fault blanking provides an accurate, preset 1.4A to 2.1A current limit, making it ideal for dual USB applications. Its low quiescent supply current (16µA) and standby current (1µA) conserve battery power in portable applications. The MAX1922 operates with inputs from 2.7V to 5.5V, making it ideal for both 3V and 5V systems.

An overcurrent signal (OC) notifies the microprocessor that the internal current limit has been reached. A 10ms overcurrent-blanking feature allows momentary faults (such as those caused when hot-swapping into a capacitive load) to be ignored, thus preventing false alarms to the host system. This blanking also prevents an OC signal from being issued when the device is powering up.

The MAX1922 has several safety features to ensure that the USB port is protected. Built-in thermal-overload protection limits power dissipation and junction temperature. The device also has accurate internal currentlimiting circuitry to protect the input supply against overload.

The MAX1922 is offered in a space-saving 8-pin SO package and a 10-pin TDFN package and operates over the extended (-40°C to +85°C) temperature range.

Applications

Notebook Computers

USB Ports

USB Hubs

Docking Stations

Features

- ♦ Accurate Current Limit (1.4A min, 2.1A max)
- ♦ 10ms Internal OC Blanking Timeout
- ♦ OC Blanking During Power-Up
- ♦ 125mΩ (max) High-Side MOSFET
- **♦** Short-Circuit and Thermal Protection with **Overcurrent Logic Output**
- ♦ Undervoltage Lockout
- ♦ 16µA Quiescent Supply Current
- ♦ 1µA (max) Standby Supply Current
- ♦ 2.7V to 5.5V Supply Range
- ♦ UL Recognized: UL# E211935

Ordering Information

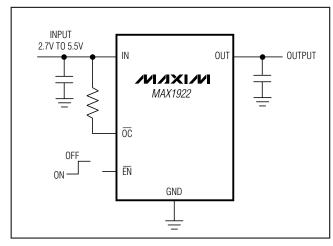
PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX1922ESA+	-40°C to +85°C	8 SO	_
MAX1922ETB+	-40°C to +85°C	10 TDFN-EP* (T1033-1)	AQQ

^{*}EP = Exposed paddle.

Pin Configurations

TOP VIEW OUT GND 1 NIXLN OUT IN 2 MAX1922 IN 3 6 OUT ŌĊ EN 4 SO Pin Configurations continued at end of data sheet.

Typical Operating Circuit



MIXIM

Maxim Integrated Products 1

⁺Denotes lead-free package.

ABSOLUTE MAXIMUM RATINGS

IN, EN, OC to GND	0.3V to +6V
OUT to GND	
Maximum Switch Current	2.3A (internally limited)
OUT Short-Circuit to GND	Continuous

Continuous Power Dissipation ($T_A = +70$ °C)	
8-Pin SO (derate 5.88mW/°C above +70°C)4	71mW
10-Pin TDFN (derate 18.5mW/°C above +70°C)14	81mW
Operating Temperature Range (extended)40°C to	+85°C
Storage Temperature Range65°C to +	150°C
Lead Temperature (soldering, 10s)+	300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 5V, T_A = 0$ °C to +85°C, unless otherwise noted. Typical values are at $T_A = +25$ °C.)

PARAMETER	SYMBOL	CONI	DITIONS	MIN	TYP	MAX	UNITS
OPERATING CONDITION	•						
Input Voltage	VIN			2.7		5.5	V
POWER SWITCH							
		T _A = +25°C	$V_{IN} = 4.4V \text{ to } 5.5V$		70	100	
Switch Static Drain-Source On- State Resistance	R _{DS(ON)}	T 000: 0500	$V_{IN} = 4.4V \text{ to } 5.5V$			125	mΩ
State Hesistance		$T_A = 0$ °C to +85°C	$V_{IN} = 3V$		72	150	mΩ μs μs V V μA ms
Switch Turn-On Time	ton	I _{LOAD} = 400mA			80	200	μs
Switch Turn-Off Time	toff	$I_{LOAD} = 400 mA$		3	6	20	μs
ENABLE INPUT (EN)	•						
TALLEND Local board Vallage		$V_{IN} = 2.7V \text{ to } 3.6V$		2.0			
EN High-Level Input Voltage	VIH	V _{IN} = 3.7V to 5.5V	2.4			V	
EN Low-Level Input Voltage	VIL	$V_{IN} = 2.7V \text{ to } 5.5V$				0.8	V
EN Input Current		VEN = VIN or GND		-1		1	μΑ
Startup Time		$V_{IN} = 5V$, $C_{OUT} = 150$ to 50% full V_{OUT}		1		ms	
CURRENT LIMIT	I						
Overload Output Current	ILIMIT	Force V _{OUT} to 4.5V	1.4	1.75	2.1	А	
Short-Circuit Output Current	Isc	OUT shorted to GND		1	1.4	Α	
SUPPLY CURRENT	•						
Supply Current, Low-Level Input		VEN = VIN = VOUT =	5.5V		0.002	1	μΑ
Supply Current, High-Level			Timer not running		16	25	^
Input	IQ	$V_{\overline{EN}} = 0$, $I_{OUT} = 0$	Timer running		35		μΑ
Cumply Logicoro Cumpost		$V_{\overline{EN}} = V_{IN} = 5.5V,$	T _A = +25°C		0.01	2	μΑ
Supply-Leakage Current		V _{OUT} = 0	$T_A = 0$ °C to +85°C			15	
UNDERVOLTAGE LOCKOUT							
Undervoltage Lockout	UVLO	Rising edge, 100mV	2.0	2.4	2.6	V	
OVERCURRENT (OC)							
OC Threshold				1.1			А
OC Output Low Voltage	VoL	I _{SINK} = 1mA, V _{IN} = 3	V			0.4	V

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 5V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OC Off-State Current		$V_{IN} = V_{\overline{OC}} = 5V$			1	μΑ
OC Blanking Timeout Period	t _{BL}	From overcurrent condition to OC assertion	6	10	13	ms
THERMAL SHUTDOWN						
Thermal Shutdown Threshold				165	•	°C

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 5V, T_A = -40$ °C to +85°C, unless otherwise noted.) (Note 1)

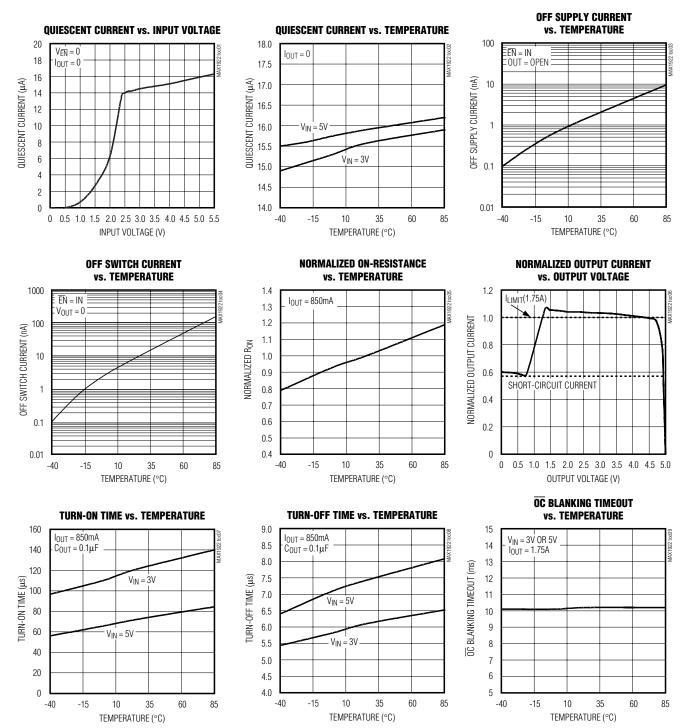
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OPERATING CONDITION						
Input Voltage	VIN		3.0		5.5	V
POWER SWITCH			•			
Switch Static Drain-Source	Б	V _{IN} = 4.4V to 5.5V			125	0
On-State Resistance	R _{DS(ON)}	V _{IN} = 3V			150	mΩ
Switch Turn-On Time	ton	I _{LOAD} = 400mA			200	μs
Switch Turn-Off Time	tOFF	I _{LOAD} = 400mA	1		20	μs
ENABLE INPUT (EN)						
TN High Level least Voltage	V	V _{IN} = 3.0V to 3.6V	2.0			V
EN High-Level Input Voltage	VIH	V _{IN} = 3.7V to 5.5V	2.4	2.4		V
EN Low-Level Input Voltage	V _{IL}	V _{IN} = 3.0V to 5.5V			0.8	V
EN Input Current		$V_{\overline{EN}} = V_{IN}$ or GND	-1		1	μΑ
CURRENT LIMIT						
Overload Output Current	I _{LIMIT}	Force V _{OUT} to 4.5V	1.2		2.3	А
Short-Circuit Output Current	Isc	OUT shorted to GND			1.5	А
SUPPLY CURRENT						
Supply Current, Low-Level Input		$V_{\overline{EN}} = V_{IN} = V_{OUT} = 5.5V$			2	μΑ
Supply Current, High-Level Input	IQ	$V_{\overline{EN}} = GND$, $I_{OUT} = 0$, timer not running			25	μΑ
Supply Leakage Current		VEN = VIN = 5.5V, VOUT = GND			15	μΑ
UNDERVOLTAGE LOCKOUT	I		1			.1
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis	2.0		2.9	V
OVERCURRENT (OC)						
OC Threshold			1.1			А
OC Output Low Voltage	VoL	I _{SINK} = 1mA, V _{IN} = 3V			0.4	V
OC Off-State Current		$V_{IN} = V_{\overline{OC}} = 5V$			1	μΑ
OC Blanking Timeout Period	t _{BL}	From overcurrent condition to OC assertion	6		14	ms

Note 1: Specifications to -40°C are guaranteed by design, not production tested.



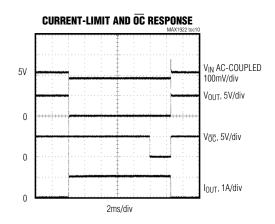
Typical Operating Characteristics

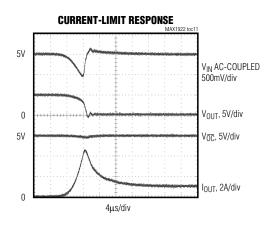
(Circuit of Figure 2, $V_{IN} = 5V$, $T_A = +25$ °C, unless otherwise noted.)

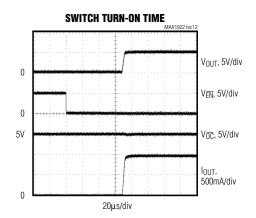


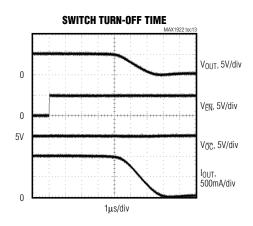
Typical Operating Characteristics (continued)

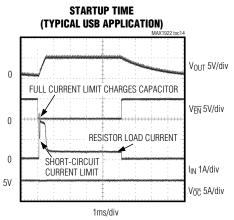
(Circuit of Figure 2, $V_{IN} = 5V$, $T_A = +25$ °C, unless otherwise noted.)











Pin Description

PACK	CKAGE				FUNCTION
TDFN	SO	NAME	FUNCTION		
6	1	GND	Ground		
1, 3, 9	2, 3	IN	Input. p-channel MOSFET source—connect all IN pins together and bypass with a 1µF capacitor ground.		
5	4	ĒN	Active-Low Switch Enable Input. A logic-low turns on the switch.		
7	5	ŌC	Overcurrent-Indicator Output. This open-drain output goes low when the device is in thermal shutdown or undervoltage lockout, or during a sustained (10ms) current-limit condition.		
2, 4, 8, 10	6, 7, 8	OUT	Switch Output. p-channel MOSFET drain—connect all OUT pins together and bypass with a 0.1µF capacitor to ground.		
_	_	EP	TDFN Only. Exposed paddle. Connect to the GND plane for optimum thermal dissipation. This does not remove the requirement for a proper ground.		

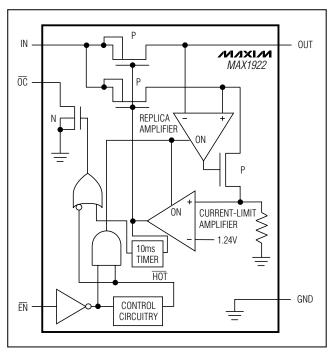


Figure 1. Functional Diagram

Detailed Description

The MAX1922 p-channel MOSFET power switch limits output current to 1.4A min and 2.1A max. When the output current increases beyond the current limit (ILIMIT), the current also increases through the replica switch (IOUT / 13000). The current-limit error amplifier compares the voltage to the internal 1.24V reference and regulates the current back to the ILIMIT (Figure 1).

These switches are not bidirectional; therefore, the input voltage must be higher than the output voltage.

Continuous Short-Circuit Protection

The MAX1922 is a short-circuit-protected switch. In the event of an output short-circuit condition, the current through the switch is foldback-current-limited to 1A continuous.

Thermal Shutdown

The MAX1922 has a thermal shutdown feature. The switch turns off and the \overline{OC} output goes low immediately (no overcurrent blanking) when the junction temperature exceeds +165°C. When the MAX1922 cools 20°C, the switch turns back on. If the fault short-circuit condition is not removed, the switch cycles on and off, resulting in a pulsed output.

OC Indicator

The MAX1922 provides an overcurrent output (\overline{OC}) . A 100k Ω pullup resistor from \overline{OC} to IN provides a logic control signal. This open-drain output goes low when any of the following conditions occur:

- The input voltage is below the 2.4V undervoltage lockout (UVLO) threshold.
- The die temperature exceeds the thermal shutdown temperature limit of +165°C.
- The device is in current limit for greater than 10ms.

OC Blanking

The MAX1922 features 10ms overcurrent blanking. Blanking allows brief current-limit faults, including momentary short-circuit faults that occur when hotswapping a capacitive load, and ensures that no \overline{OC} is issued during power-up. When a load transient causes the device to enter current limit, an internal counter starts. If the load fault persists beyond the 10ms overcurrent blanking timeout, the \overline{OC} output asserts low. Ensure that the MAX1922 input is adequately bypassed to prevent input glitches from triggering spurious \overline{OC}

outputs. Input voltage glitches less than 150mV do not cause a spurious \overline{OC} output. Load-transient faults less than 10ms (typ) will not cause an \overline{OC} output assertion.

Only current-limit faults are blanked. Die overtemperature faults and input voltage droops below the UVLO threshold will cause an immediate \overline{OC} output.

Applications Information

Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor from IN to GND. A 1µF ceramic capacitor is adequate for most applications; however, higher capacitor values further reduce the voltage drop at the input (Figure 2).

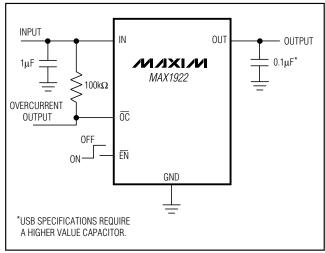


Figure 2. Typical Application Circuit

Output Capacitor

Connect a 0.1µF capacitor from OUT to GND. This capacitor helps to prevent inductive parasitics from pulling OUT negative during turn-off.

Layout and Thermal Dissipation

Important: Optimize the switch response time to output short-circuit conditions by keeping all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close as possible to the device (no more than 5mm away). All IN and OUT pins must be connected with short traces to the power bus. Wide power-bus planes provide superior heat dissipation through the MAX1922's IN and OUT pins. Under normal operating conditions, the package can dissipate and channel heat away. Calculate the maximum power dissipation as follows:

$$P = (I_{LIMIT})^2 \times R_{ON}$$

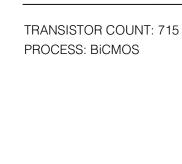
where I_{LIMIT} is the preset current limit (2.1A max) and R_{ON} is the on-resistance of the switch (125m Ω max).

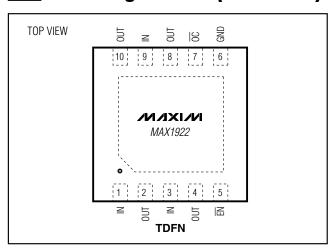
When the output is short circuited, foldback-current limiting activates and the voltage drop across the switch equals the input supply voltage. The power dissipated across the switch increases, as does the die temperature. If the fault condition is not removed, the thermal-overload protection circuitry activates (see *Thermal Shutdown* section). Wide power-bus planes connected to IN and OUT and a ground plane in contact with the device help dissipate additional heat.

Driving Inductive Loads

A wide variety of devices (mice, keyboards, cameras, and printers) can load the USB port. These devices commonly connect to the port with cables, which can add an inductive component to the load. This inductance causes the output voltage at the USB port to ring during a load step. The MAX1922 is capable of driving inductive loads, but avoid exceeding the device's absolute maximum ratings. Usually the load inductance is relatively small, and the MAX1922 input includes a substantial bulk capacitance from an upstream regulator as well as local bypass capacitors, limiting overshoot. If severe ringing occurs due to large load inductance, clamp the MAX1922 output below 6V and above -0.3V.

Pin Configurations (continued)

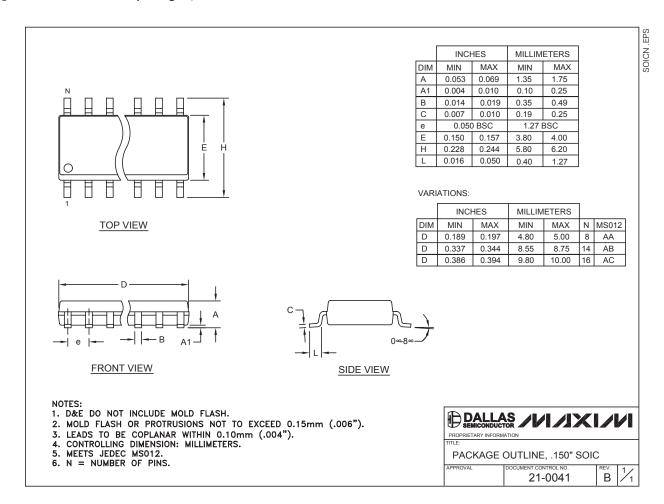




Chip Information

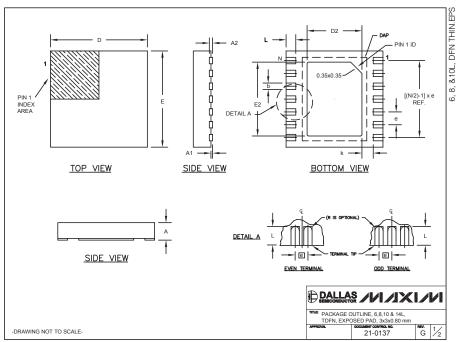
Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



COMM	ION DIME	NSIONS	1							
SYMBO	MIN.	MAX.	1							
A	0.70	0.80	i							
D	2.90	3.10								
E	2.90	3.10								
A1	0.00	0.05								
L	0.20	0.40								
k	_	25 MIN.	1							
A2	0.3	20 REF.	J							
PACKAGE VA	RIATIONS								7	
PKG. CODE	N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e	DOWNBONDS ALLOWED	3	
T633-1	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO	7	
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF	NO	7	
T833-1	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO	7	
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	NO	7	
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF	YES	7	
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF	NO		
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	YES		
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF	NO		
5. DRAWING (AND T143	TY SHALL SHALL NO ENGTH/F CHARACTE CONFORM 13-1 &	NOT EXC OT EXCEED PACKAGE W RISTIC(S). S TO JEDE	EED 0.08 n 0.10 mm. IDTH ARE 0 0 MO229, I	om. ONSIDERED	as Iensions "d2" ani	D "E2",]	DALLAS	//I/IX	

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

10 Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600